

Field Engineering and Technology**Revision and Rollover of *Electronic Engineering* unit standards**

| Subfield | Domain | ID |
|------------------------|--------------------------|---------------------------------|
| Electronic Engineering | Electronic Manufacturing | 12573-12592, 20400-20404, 20524 |

The ElectroTechnology Industry Training Organisation (ETITO) has completed the revision of the unit standards listed above. The standards have also been rolled over to maintain their currency until they are reviewed.

Date new versions published

March 2010

Planned review date

December 2013

Summary

These unit standards have been revised to ensure currency. The ETITO plan to carry out a review of all the standards in the Electronic Manufacturing domain in 2013.

Main changes

- Changes reflect new standards format.
- Special notes have been updated to refer to current codes of practice and standards.
- Special notes have been updated to refer to current reference material.

Impact on existing accreditations

None.

Impact on Accreditation and Moderation Action Plan (AMAP)

None.

Impact on registered qualifications

None.

Detailed list of unit standards – classification, title, level, and credits

All changes are in **bold**.

Engineering and Technology > Electronic Engineering > Electronic Manufacturing

| ID | Title | Level | Credit |
|-----------|--|--------------|---------------|
| 12573 | Deal with hazardous materials in an electronic manufacturing environment | 3 | 10 |
| 12574 | Pack electronic products | 2 | 10 |
| 12575 | Assemble through-hole printed circuit boards manually | 3 | 10 |
| 12576 | Assemble surface mount printed circuit boards manually | 3 | 15 |

| ID | Title | Level | Credit |
|-----------|--|--------------|---------------|
| 12577 | Assemble electronic products | 3 | 15 |
| 12578 | Assemble electronic components | 3 | 15 |
| 12579 | Perform hand soldering in electronic manufacturing | 3 | 10 |
| 12580 | Operate printed circuit board flow soldering equipment | 3 | 10 |
| 12581 | Operate automatic assembly equipment for printed circuit boards | 3 | 35 |
| 12582 | Control printed circuit board fabrication operations | 3 | 30 |
| 12583 | Control printed circuit board manufacturing processes | 3 | 30 |
| 12584 | Control printed circuit board screenprinting processes | 3 | 30 |
| 12585 | Prepare screenprinting stencils for printed circuit board processes | 3 | 20 |
| 12586 | Apply protective coatings to electronic products | 3 | 10 |
| 12587 | Inspect electronic products visually | 3 | 10 |
| 12588 | Conduct go/no-go testing of electronic products in electronic manufacturing | 3 | 10 |
| 12589 | Test and adjust electronic products in electronic manufacturing | 4 | 20 |
| 12590 | Repair printed circuit boards | 4 | 20 |
| 12591 | Prepare production batches for manufacture of electronic products | 4 | 15 |
| 12592 | Manage the production of electronic products within a manufacturing cell | 4 | 30 |
| 20400 | Rework surface mount printed circuit boards | 3 | 10 |
| 20401 | Rework through-hole printed circuit boards | 3 | 10 |
| 20402 | Identify and follow safety practices and procedures in an electronic manufacturing environment | 2 | 5 |
| 20403 | Identify electronic components | 2 | 5 |
| 20404 | Assemble electronic equipment racks or cabinets | 3 | 20 |
| 20405 | Describe and use electrostatic discharge control procedures in electronic manufacturing | 2 | 2 |
| 20524 | Assemble through-hole printed circuit boards using semi-automatic assembly equipment | 3 | 10 |